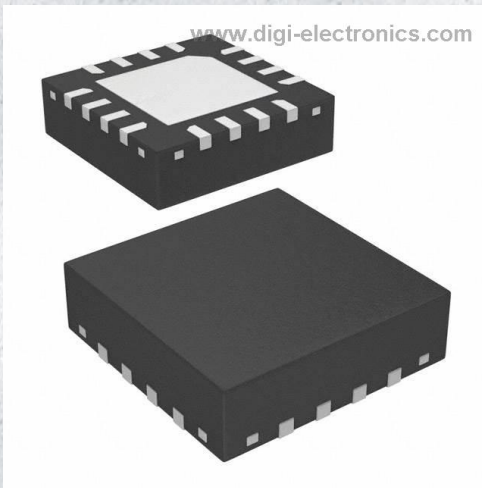


# RT9147ZQW Datasheet



<https://www.DiGi-Electronics.com>

DiGi Electronics Part Number	RT9147ZQW-DG
Manufacturer	<a href="#">Richtek USA Inc.</a>
Manufacturer Product Number	RT9147ZQW
Description	IC OPAMP GP 1 CIRCUIT 16WQFN
Detailed Description	General Purpose Amplifier 1 Circuit Rail-to-Rail 16-WQFN (4x4)



Tel: +00 852-30501935

RFQ Email: [Info@DiGi-Electronics.com](mailto:Info@DiGi-Electronics.com)

DiGi is a global authorized distributor of electronic components.

## Purchase and inquiry

Manufacturer Product Number:

RT9147ZQW

Series:

-

Amplifier Type:

General Purpose

Output Type:

Rail-to-Rail

Gain Bandwidth Product:

12 MHz

Current - Input Bias:

2 nA

Current - Supply:

4mA

Voltage - Supply Span (Min):

6 V

Operating Temperature:

-40°C ~ 85°C

Package / Case:

16-WQFN Exposed Pad

Base Product Number:

RT9147

Manufacturer:

Richtek USA Inc.

Product Status:

Active

Number of Circuits:

1

Slew Rate:

35V/μs

-3db Bandwidth:

16 MHz

Voltage - Input Offset:

2 mV

Current - Output / Channel:

1.4 A

Voltage - Supply Span (Max):

20 V

Mounting Type:

Surface Mount

Supplier Device Package:

16-WQFN (4x4)

## Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8542.33.0001

Moisture Sensitivity Level (MSL):

3 (168 Hours)

ECCN:

EAR99

## 20V, 1A, Rail-to-Rail Operational Amplifier

### General Description


The RT9146/7 consists of a low power, high slew rate, single supply rail-to-rail input and output operational amplifier.


The RT9146 contains a single amplifier and the RT9147 contains two amplifiers in one package.

The RT9146/7 has a high slew rate (35V/μs), 1A peak output current and offset voltage below 15mV. The RT9146/7 is ideal for Thin Film Transistor Liquid Crystal Displays (TFT-LCD).

The RT9146 is available in the WDFN-8L 3x3 package, and the RT9147 is available in the WQFN-16L 4x4 package. The RT9146/7 are specified for operation over the full -40°C to 85°C temperature range.

### Ordering Information

RT9146	
	Package Type
	QW : WDFN-8L 3x3
	QWA : WDFN-8SL 3x3
	Lead Plating System
	Z : ECO (Ecological Element with Halogen Free and Pb free)

RT9147	
	Package Type
	QW : WQFN-16L 4x4
	Lead Plating System
	Z : ECO (Ecological Element with Halogen Free and Pb free)

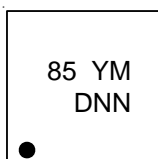
Note :

Richtek products are :

- ▶ RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

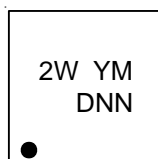
### Marking Information

RT9146ZQW



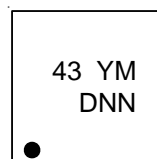
85 : Product Code  
YMDNN : Date Code

RT9146ZQWA



2W : Product Code  
YMDNN : Date Code

RT9147ZQW



43 : Product Code  
YMDNN : Date Code

### Features

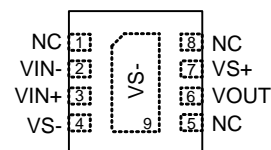
- Rail-to-Rail Output Swing
- Supply Voltage : 6V to 20V
- Peak Output Current : 1A
- High Slew Rate : 35V/μs
- Unity Gain Stable
- RoHS Compliant and Halogen Free

### Applications

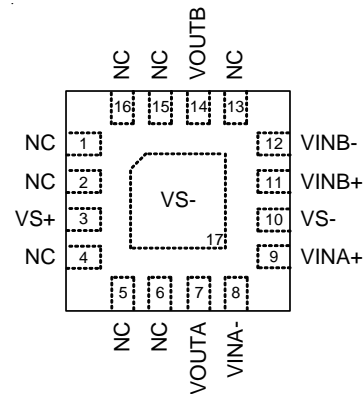
- TFT-LCD Panels
- Notebook Computers
- Monitors
- LCD TVs

### Pin Configurations

(TOP VIEW)

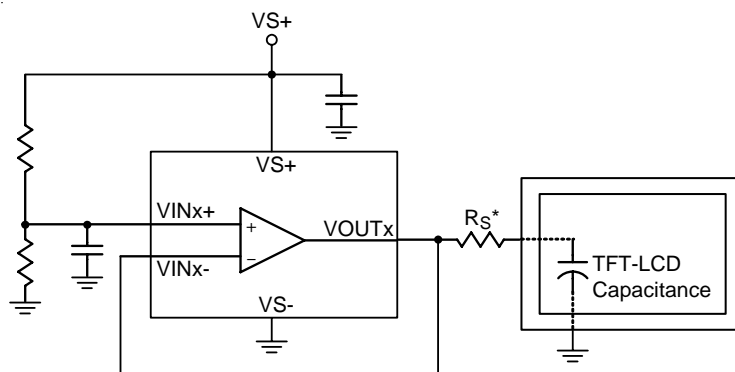


WDFN-8L 3x3 / WDFN-8SL 3x3  
RT9146



WQFN-16L 4x4  
RT9147

## Typical Application Circuit



\* :  $R_S$  may be needed for some applications.

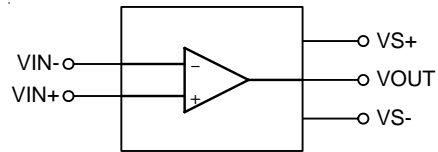
## Functional Pin Description

RT9146

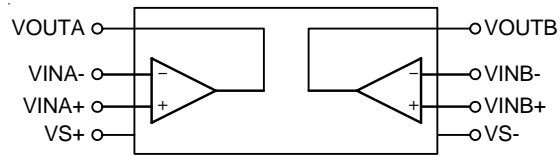
Pin No.		Pin Name	Pin Function
WDFN-8L 3x3	WDFN-8SL 3x3		
1, 5, 8		NC	No Internal Connection.
2		VIN-	Negative Input.
3		VIN+	Positive Input.
4, 9 (Exposed Pad)		VS-	Negative Supply Input. The exposed pad must be soldered to a large PCB and connected to VS- for maximum power dissipation.
6		VOUT	Output.
7		VS+	Positive Supply Input. Bypass VS+ to VS- with a 0.1 $\mu$ F capacitor placed as close as possible to the device.

RT9147

Pin No.		Pin Name	Pin Function
1, 2, 4, 5, 6, 13, 15, 16			
3		VS+	Positive Supply Input. Bypass VS+ to VS- with a 0.1 $\mu$ F capacitor placed as close as possible to the device.
7		VOUTA	Output of Amplifier A.
8		VINA-	Positive Input of Amplifier A.
9		VINA+	Negative Input of Amplifier A.
10, 17 (Exposed Pad)		VS-	Negative Supply Input. The exposed pad must be soldered to a large PCB and connected to VS- for maximum power dissipation.
11		VINB+	Positive Input of Amplifier B.
12		VINB-	Negative Input of Amplifier B.
14		VOUTB	Output of Amplifier B.

**Function Block Diagram**


RT9146



RT9147

## Absolute Maximum Ratings (Note 1)

• Supply Voltage, (VS+ to VS-) -----	24V
• VINx+, VINx- to VS- -----	-0.3V to 24V
• VINx+ to VINx- -----	±5V
• Power Dissipation, PD @ TA = 25°C	
WDFN-8L 3x3 -----	3.22W
WDFN-8SL 3x3 -----	3.22W
WQFN-16L 4x4 -----	3.51W
• Package Thermal Resistance (Note 2)	
WDFN-8L 3x3, θJA -----	31°C/W
WDFN-8L 3x3, θJC -----	8°C/W
WDFN-8SL 3x3, θJA -----	31°C/W
WDFN-8SL 3x3, θJC -----	8°C/W
WQFN-16L 4x4, θJA -----	28.5°C/W
WQFN-16L 4x4, θJC -----	7°C/W
• Lead Temperature (Soldering, 10 sec.) -----	260°C
• Junction Temperature -----	150°C
• Storage Temperature Range -----	-65°C to 150°C
• ESD Susceptibility (Note 3)	
HBM (Human Body Model) -----	2kV
MM (Machine Model) -----	200V

## Recommended Operating Conditions (Note 4)

• Supply Voltage, VS- = 0V, VS+ -----	6V to 20V
• Junction Temperature Range -----	-40°C to 125°C
• Ambient Temperature Range -----	-40°C to 85°C

## Electrical Characteristics

(VS+ = 16V, VS- = 0V, VINx+ = VOUTx = VS+ / 2, TA = 25°C, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Input Characteristics</b>						
Input Offset Voltage	VOS	VCM = VS+ / 2	--	2	15	mV
Input Bias Current	IB	VCM = VS+ / 2	--	2	50	nA
Load Regulation	ΔVLOAD	IOUTx = 0 to -80mA	--	0.1	--	mV/mA
		IOUTx = 0 to 80mA	--	-0.1	--	
Common Mode Input Range	CMIR		0.5	--	VS+ -0.5	V
Common Mode Rejection Ratio	CMRR	0.5V ≤ VOUTx ≤ VS+ - 0.5V	--	95	--	dB
Open Loop Gain	AVOL	0.5V ≤ VOUTx ≤ VS+ - 0.5V	--	118	--	dB

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Output Characteristics</b>						
Output Swing Low	$V_{OL}$	$I_L = -50\text{mA}$	--	0.6	1.5	V
Output Swing High	$V_{OH}$	$I_L = 50\text{mA}$	$V_{S+} - 1.5$	$V_{S+} - 0.3$	--	V
Transient Peak Output Current	$I_{PK}$		800	1000	1400	mA
<b>Power Supply</b>						
Power Supply Rejection Ratio	PSRR	$V_{S+} = 6\text{V to } 20\text{V}, V_{CM} = V_{OUTx} = V_{S+} / 2$	--	96	--	dB
Quiescent Current	$I_{DD}$	No Load	--	4	--	mA
<b>Dynamic Performance</b>						
Slew Rate	SR	4V step, 20% to 80%, $A_V = 1$	--	35	--	V/ $\mu\text{s}$
Setting to $\pm 0.1\%$ ( $A_V = 1$ )	$t_S$	$A_V = 1, V_{OUTx} = 2\text{V step}$ $R_L = 10\text{k}\Omega, C_L = 10\text{pF}$	--	270	--	ns
-3dB Bandwidth	BW	$R_L = 10\text{k}\Omega, C_L = 10\text{pF}$	--	16	--	MHz
Gain-Bandwidth Product	GBWP	$R_L = 10\text{k}\Omega, C_L = 10\text{pF}$	--	12	--	MHz
Phase Margin	PM	$R_L = 10\text{k}\Omega, C_L = 10\text{pF}$	--	$50^\circ$	--	--
Thermal Shutdown Temperature	$T_S$	Temperature Rising	--	150	--	$^\circ\text{C}$
Thermal Shutdown Hysteresis	$\Delta T_S$		--	20	--	$^\circ\text{C}$

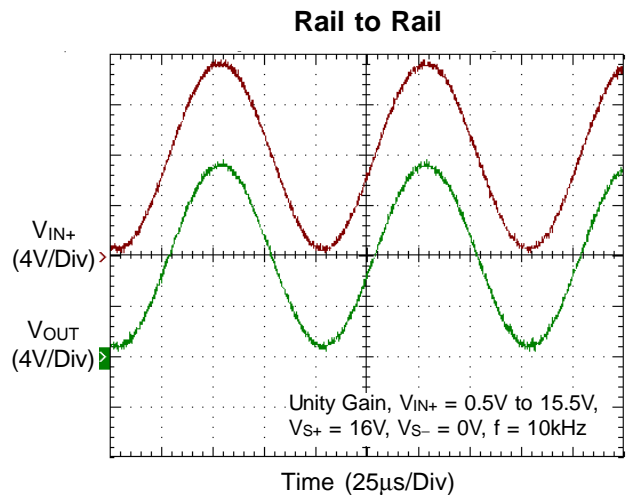
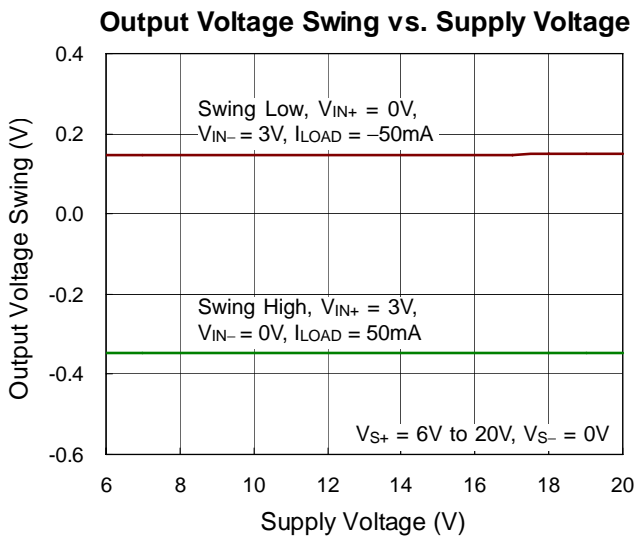
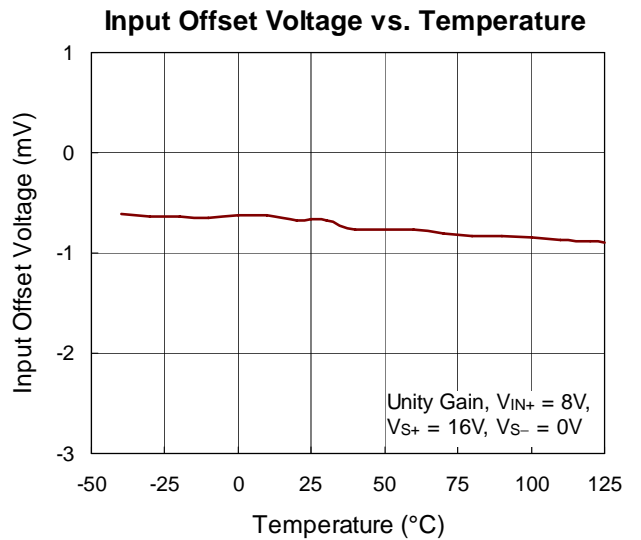
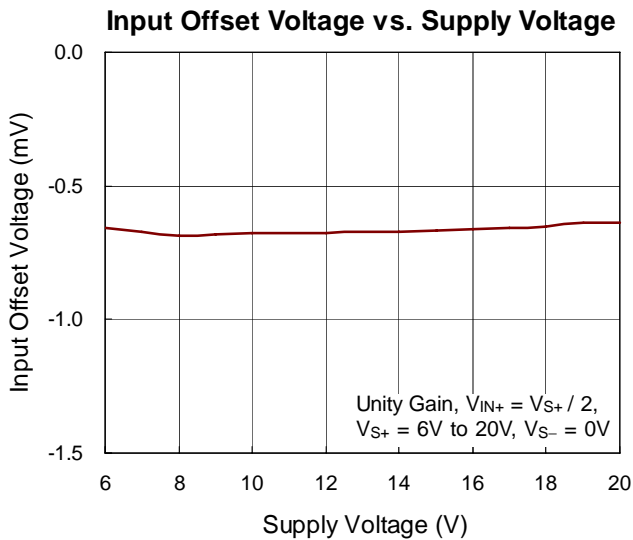
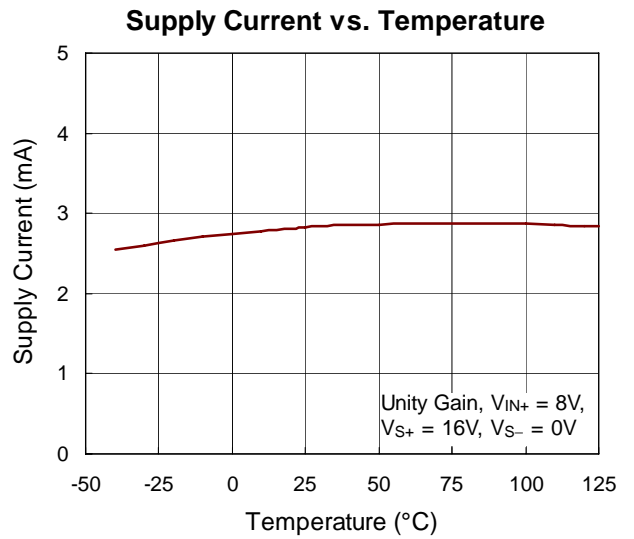
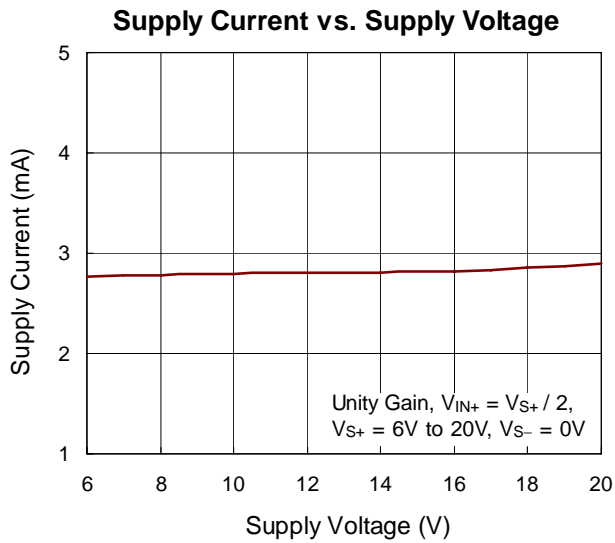
**Note 1.** Stresses beyond those listed "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

**Note 2.**  $\theta_{JA}$  is measured at  $T_A = 25^\circ\text{C}$  on a high effective thermal conductivity four-layer test board per JEDEC 51-7.  $\theta_{JC}$  is measured at the exposed pad of the package.

**Note 3.** Devices are ESD sensitive. Handling precaution is recommended.

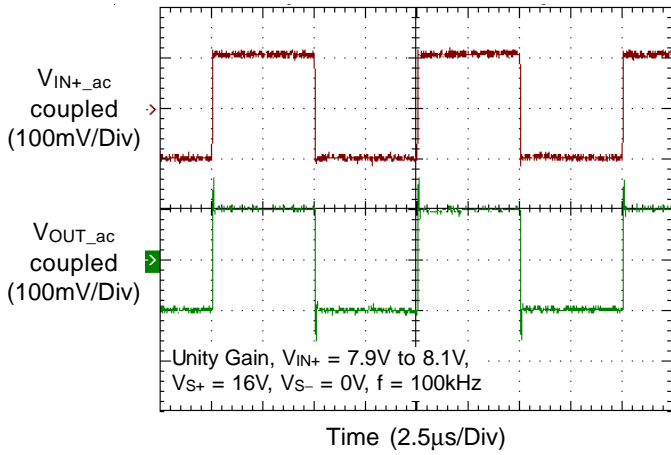
**Note 4.** The device is not guaranteed to function outside its operating conditions.

Typical Operating Characteristics

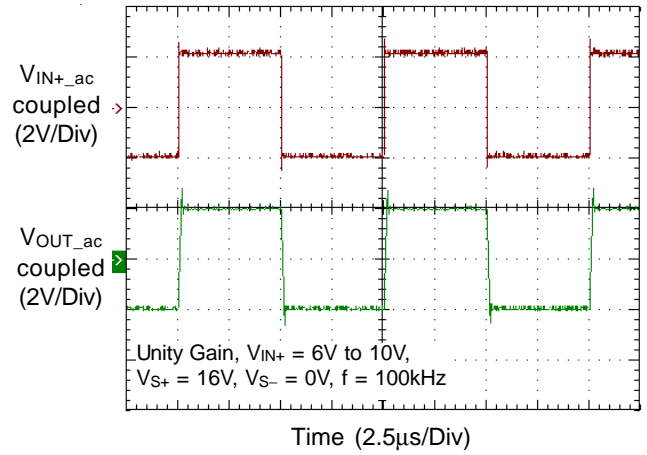




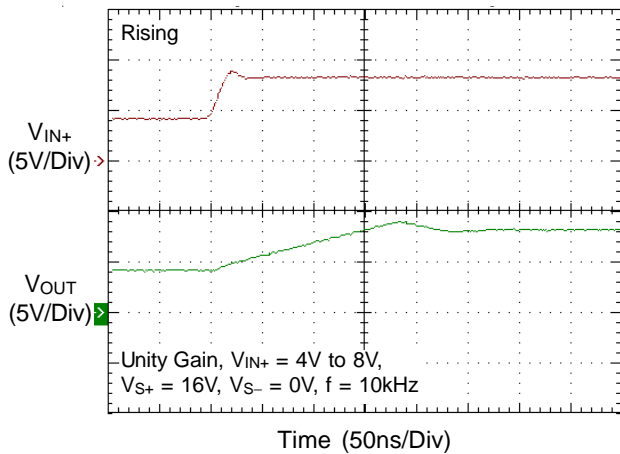
**Small Signal Response**



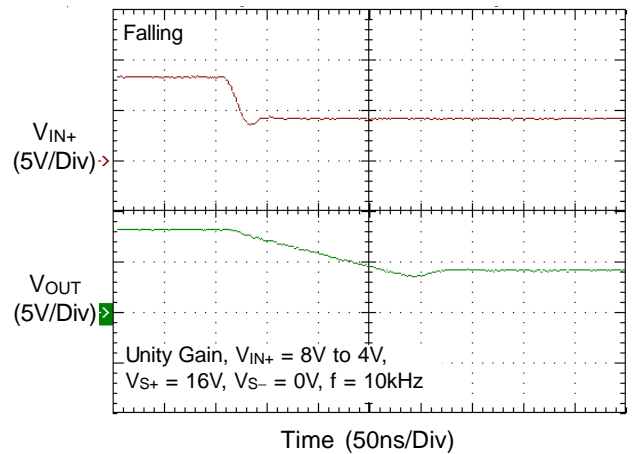
**Large Signal Response**



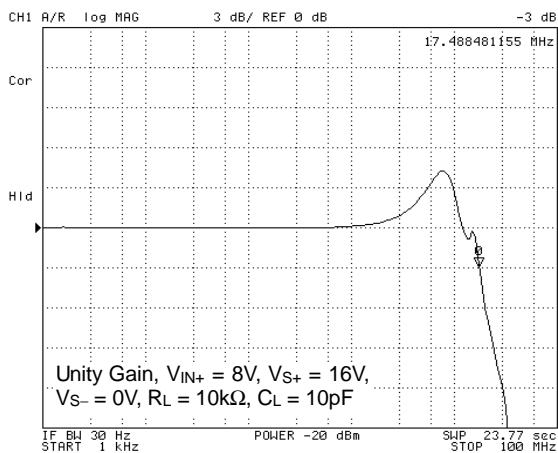
**Slew Rate**



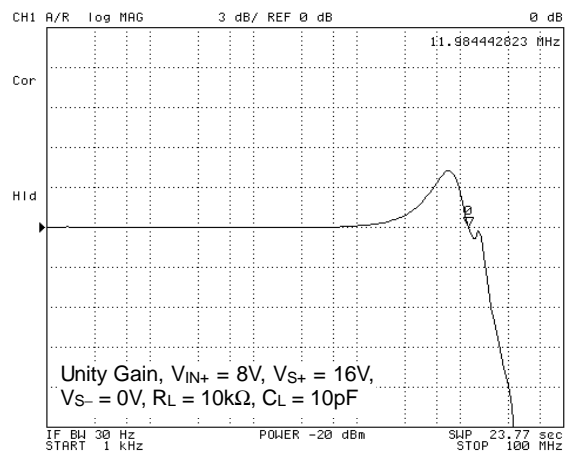
**Slew Rate**



**-3dB Bandwidth**



**Gain Bandwidth Product**



## Applications Information

The RT9146/7 is a high performance operational amplifier capable of driving large loads for different applications. A high slew rates, rail-to-rail input and output capability, and low power consumption are the features which make the RT9146/7 ideal for LCD applications. The RT9146/7 also has wide bandwidth and phase margin to drive a load with 10kΩ resistance and 10pF capacitance.

### Operating Voltage

The RT9146/7 total supply voltage range is guaranteed from 6V to 20V. The specifications are stable over both full supply range and operating temperatures from -40°C to 85°C. The output swing of the RT9146/7 typically extends to within 1.5V of positive/negative supply rails with 50mA load current source/sink. Decreasing the load current will obtain an output swing even closer to the supply rails.

### Short-Circuit Condition

An internal short-circuit protection is implemented to protect the device from output short-circuit. The RT9146/7 limits the short-circuit current to ±1A if the output is directly shorted to positive/negative supply rails.

### LCD Panel Applications

The RT9146/7 is mainly designed for LCD V-com buffer. The operational amplifier has 1A instantaneous source/sink peak current.

### Thermal Considerations

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula :

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where  $T_{J(MAX)}$  is the maximum junction temperature,  $T_A$  is the ambient temperature, and  $\theta_{JA}$  is the junction to ambient thermal resistance.

For recommended operating condition specifications, the maximum junction temperature is 125°C. The junction to ambient thermal resistance,  $\theta_{JA}$ , is layout dependent. For WDFN-8L 3x3 package, the thermal resistance,  $\theta_{JA}$ , is 31°C/W on a standard JEDEC 51-7 four-layer thermal test board. For WDFN-8SL 3x3 package, the thermal resistance,  $\theta_{JA}$ , is 31°C/W on a standard JEDEC 51-7 four-layer thermal test board. For WQFN-16L 4x4 package, the thermal resistance,  $\theta_{JA}$ , is 28.5°C/W on a standard JEDEC 51-7 four-layer thermal test board. The maximum power dissipation at  $T_A = 25^\circ\text{C}$  can be calculated by the following formula :

$$P_{D(MAX)} = (125^\circ\text{C} - 25^\circ\text{C}) / (31^\circ\text{C/W}) = 3.22\text{W for WDFN-8L 3x3 package}$$

$$P_{D(MAX)} = (125^\circ\text{C} - 25^\circ\text{C}) / (31^\circ\text{C/W}) = 3.22\text{W for WDFN-8SL 3x3 package}$$

$$P_{D(MAX)} = (125^\circ\text{C} - 25^\circ\text{C}) / (28.5^\circ\text{C/W}) = 3.51\text{W for WQFN-16L 4x4 package}$$

The maximum power dissipation depends on the operating ambient temperature for fixed  $T_{J(MAX)}$  and thermal resistance,  $\theta_{JA}$ . The derating curve in Figure 1 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

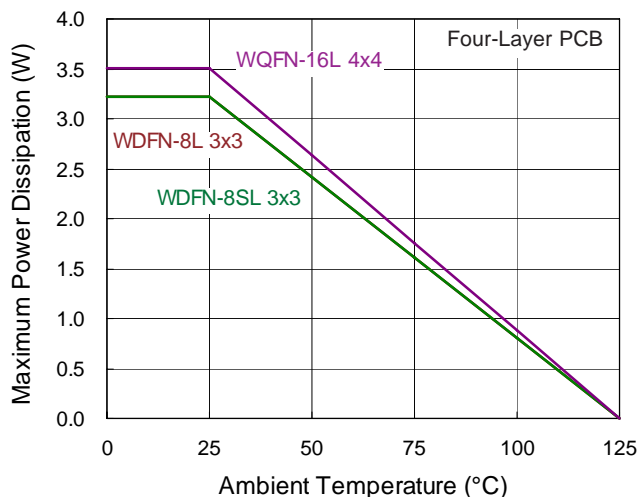


Figure 1. Derating Curve of Maximum Power Dissipation

**Layout Consideration**

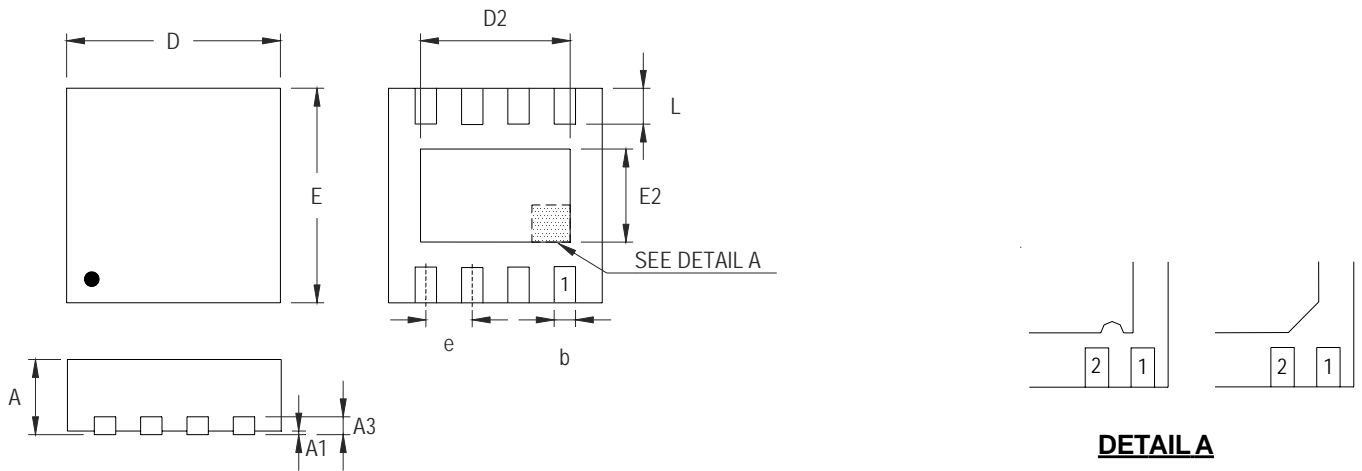
PCB layout is very important for designing power converter circuits. The following layout guidelines should be strictly followed for best performance of the RT9146/7.

- ▶ Place the power components as close to the IC as possible. The traces should be wide and short, especially for the high current loop.
- ▶ A series resistance may be needed at the output for some applications.
- ▶ Connect a 0.1 $\mu$ F capacitor from VINx+ to ground and place it as close to the IC as possible for better performance.
- ▶ The exposed pad of the chip should be connected to a large PCB plane for maximum thermal consideration.

# RT9146/7



## Outline Dimension



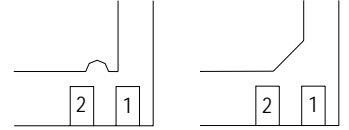
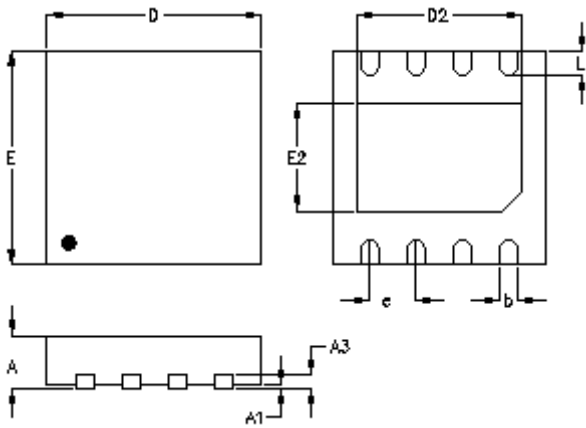
### DETAIL A

Pin #1 ID and Tie Bar Mark Options

Note : The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A3	0.175	0.250	0.007	0.010
b	0.200	0.300	0.008	0.012
D	2.950	3.050	0.116	0.120
D2	2.100	2.350	0.083	0.093
E	2.950	3.050	0.116	0.120
E2	1.350	1.600	0.053	0.063
e	0.650		0.026	
L	0.425	0.525	0.017	0.021

W-Type 8L DFN 3x3 Package



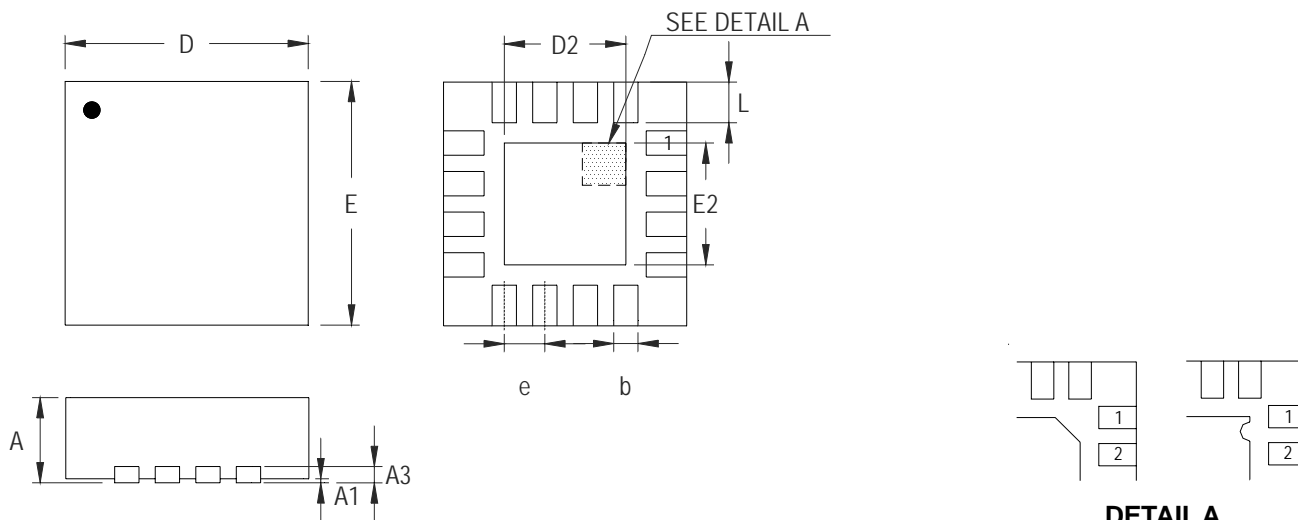
#### DETAILA

Pin #1 ID and Tie Bar Mark Options

Note : The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A3	0.175	0.250	0.007	0.010
b	0.200	0.300	0.008	0.012
D	2.900	3.100	0.114	0.122
D2	2.250	2.350	0.089	0.093
E	2.900	3.100	0.114	0.122
E2	1.450	1.550	0.057	0.061
e	0.650		0.026	
L	0.300	0.400	0.012	0.016

#### W-Type 8SL DFN 3x3 Package

**DETAIL A**

Pin #1 ID and Tie Bar Mark Options

Note : The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A3	0.175	0.250	0.007	0.010
b	0.250	0.380	0.010	0.015
D	3.950	4.050	0.156	0.159
D2	2.000	2.450	0.079	0.096
E	3.950	4.050	0.156	0.159
E2	2.000	2.450	0.079	0.096
e	0.650		0.026	
L	0.500	0.600	0.020	0.024

**W-Type 16L QFN 4x4 Package****Richtek Technology Corporation**

5F, No. 20, Taiyuen Street, Chupei City

Hsinchu, Taiwan, R.O.C.

Tel: (8863)5526789

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